#### **SPECIFICATIONS**

CUSTOMER . PTC

SAMPLE CODE . SH240320T068-LAA06

MASS PRODUCTION CODE . PH240320T068-LAA06

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 003

DRAWING NO. (Ver.) . JLMD-PH240320T068-LAA06\_001

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# Customer Approved

Approved	Checked	Designer
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☐ Preliminary specification for design input

■ Specification for sample approval

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# **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
01/18/2019	01	001	New Drawing	-	陳璐
03/05/2019	01	002	New Sample	-	陳璐
04/09/2019	01	003	Modify Initial code	12~14	陳璐

Total: 29 Page



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Note: For detailed information please refer to IC data sheet:

Primacy(TFT LCD): Sitronix: ST7789VI



#### 1. SPECIFICATIONS

# 1.1 Features

#### Main LCD panel

Item	Standard Value
Display Type	240(R · G · B) * 320 Dots
LCD Type	Normally white , Transmissive type
Screen size(inch)	2.8 inch
Viewing Direction	12 O'clock
Color configuration	RGB-Strip
Interface	80-16bit parallel I/F Ⅱ
Other(controller/driver IC)	Sitronix: ST7789VI
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

# 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	50.0(W) * 69.2 (L) * 3.05 (H)max	mm

# LCD panel

Item	Standard Value	
Active Area	43.2 (W) * 57.6 (L)	mm





# 1.3 Absolute Maximum Ratings

#### Module

Item	Symbol	Condition	Min.	Max.	Unit
Contain Device Constal Valle of	VCC	-	-0.3	+4.6	V
System Power Supply Voltage	VGH ~ VGL	-	-0.3	+30	V
Input Voltage	VIN	-	-0.3	VCC+0.5	V
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	T <sub>ST</sub>	-	-30	+80	°C
Storage Humidity	H <sub>D</sub>	Ta ≤ 40 °C	20	90	%RH

#### 1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

					•	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage1	VCC	·	2.4	2.8	3.6	V
Input High Voltage	VIH	-	0.7 VCC	-	VCC	V
Input Low Voltage	VIL	-	GND	-	0.3 VCC	V
Output High Voltage	Vон	IOH=-0.1mA	0.8*VCC	-	VCC	V
Output Low Voltage	V <sub>OL</sub>	IOL=0.1mA	GND	ı	0.2*VCC	V
Supply Current	ICC	VCC = 2.8V	1	8	12	mA

Note1:Maximum current display



# 1.5 Optical Characteristics

#### **TFT LCD Module**

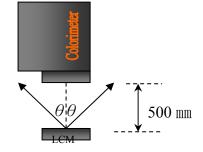
VCC = 2.8V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response tim	ne	Tr+ Tf	-	-	30	45	ms	Note2
	Тор	θΥ+		-	60	-		
Viewing angle	Bottom	θΥ-	CR ≥ 10	ı	60	-	Deg.	Note4
viewing angle	Left	θX-	CIX 2 10	1	60	-	Deg.	Note4
	Right	θX+		-	60	_		
Contrast rati	0	CR	-	500	600	-	-	Note3
	\\/bito	Х		0.24	0.29	0.34		
	White	Υ		0.26	0.31	0.36		
0.1	Dod	Х		0.57	0.62	0.67		
Color of CIE Coordinate	Red	Υ	IE-00 A	0.30	0.35	0.40		
( With B/L )	Croon	Х	IF=80 mA	0.28	0.33	0.38	_	
( ****** = /	Green	Υ		0.54	0.59	0.64		
	Blue	X		0.10	0.15	0.15 0.20		Note1
	Diue	Υ		0.03	0.08	0.13		
Average Brightness								
Pattern=white display		IV	IF=80 mA	250	350	-	cd/m <sup>2</sup>	
(With B/L) *1		4						
Uniformity (With B/L)*2	2	△B	IF=80 mA	70	-	-	%	

#### Note 1:

- \*1 : △B=B(min) / B(max) \* 100%
- \*2 : Measurement Condition for Optical Characteristics:
  - a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance:  $500 \pm 50 \text{ mm}$ ,  $(\theta = 0^{\circ})$
  - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
  - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





Colorimeter=BM-7 fast

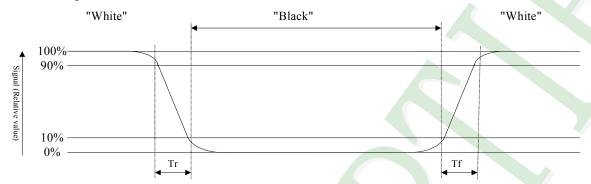
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)



#### Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

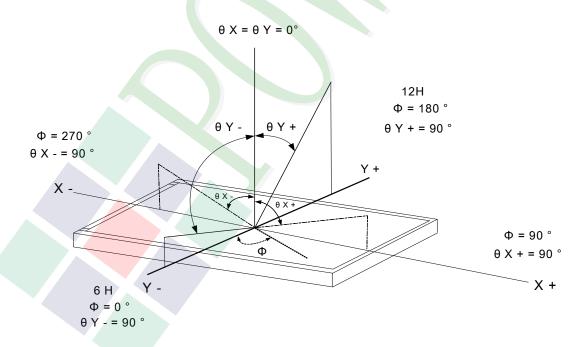
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





# 1.6 Backlight Characteristics

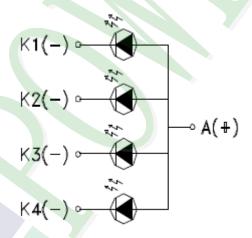
**Maximum Ratings** 

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°℃	-	30*4	mA
Reverse Voltage	VR	Ta =25°ℂ	-	5	V
Power Dissipation	PD	Ta =25°ℂ	- (	90*4	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		3.0	-	3.6	<b>V</b>
Average Brightness (without LCD)	IV	IF= 80 mA	5000	5500	<u> </u>	cd/m <sup>2</sup>
CIE Color Coordinate	X		0.26	0.28	0.33	
(Without LCD)	Y		0.26	0.28	0.33	=
Color			White			

#### **Internal Circuit**



Other Description

Item	Conditions	Description
Life Time	Ta =25℃ IF= 80 mA	20000 hrs

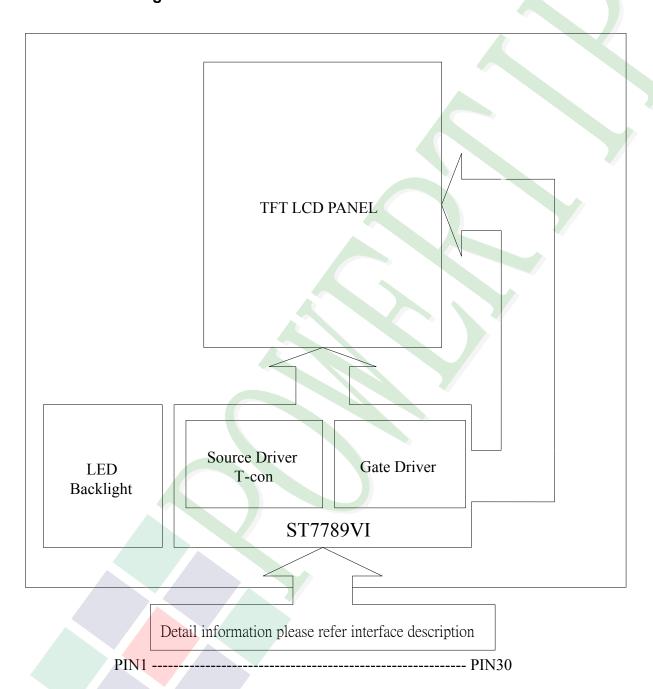


# 2.1 Counter Drawing

# 2.1.1 LCM Mechanical Diagram

\* See Appendix

# 2.1.2 Block Diagram





# 2.2 Interface Pin Description

Pin No.	Symbol	Function
1	LEDK1-4	Power supply for LED Backlight Cathode input
2	LEDA	Power supply for LED Backlight Anode input
3	GND	Signal ground.(0V)
4	RESET	Reset input pin for TFT LCD.  When RESET is "L", initialization is executed.
5	DB17	
6	DB16	
7	DB15	
8	DB14	
9	DB13	
10	DB12	
11	DB11	
12	DB10	Bi-directional data bus
13	DB8	Di-uli ectional data bus
14	DB7	
15	DB6	
16	DB5	
17	DB4	
18	DB3	
19	DB2	
20	DB1	
21	RD	Read signal input - active at Low.
22	WR/SCL	Write signal input - active at Low.
23	RS	When RS = 0: Command. When RS = 1: Display data.
24	CS	Chip select signal , Active at "L"
25	XR	NC



Pin No.	Symbol	Function
26	YD	
27	XL	NC
28	YU	
29	GND	Signal ground.(0V)
30	2.8 /VCC	Power supply for the internal logic circuit.





```
2.2.1 Reference Initial code
void LCD Init(void)
{
   LCD_WR_REG(0x01);
   delay_ms(100);
   LCD WR REG(0x11);
   delay ms(120);
   LCD WR REG(0x36);
   LCD_WR_DATA(0x00);
   LCD WR REG(0x3a);
   LCD_WR_DATA(0x55);
   LCD WR REG(0xb2);
   LCD WR DATA(0x0C);
   LCD WR DATA(0x0C);
   LCD WR DATA(0x00);
   LCD WR DATA(0x33);
   LCD WR DATA(0x33);
   LCD WR REG(0xb7);
   LCD WR DATA(0x35);
   LCD WR REG(0xbb);
   LCD WR DATA(0x19);
   LCD WR REG(0xc0);
   LCD WR DATA(0x2c);
   LCD WR REG(0xc2);
   LCD_WR_DATA(0x01);
   LCD WR REG(0xc3);
   LCD WR DATA(0x12);
```



```
LCD WR REG(0xc4);
  LCD WR DATA(0x20);
  LCD WR REG(0xc6);
  LCD WR DATA(0x0f);
  LCD WR REG(0xd0);
  LCD WR_DATA(0xa4);
  LCD WR DATA(0xa1);
/*-----*/
  LCD WR REG(0xe0);
  LCD WR DATA(0xd0);
  LCD_WR_DATA(0x04);
  LCD_WR_DATA(0x0d);
  LCD WR DATA(0x11);
  LCD WR DATA(0x13);
  LCD WR DATA(0x2b);
  LCD WR DATA(0x3f);
  LCD WR DATA(0x54);
  LCD WR DATA(0x4c);
  LCD WR DATA(0x18);
  LCD_WR_DATA(0x0d);
  LCD WR DATA(0x0b);
  LCD_WR_DATA(0x1f);
  LCD WR DATA(0x23);
  LCD WR REG(0xe1);
  LCD WR DATA(0xd0);
  LCD_WR_DATA(0x04);
  LCD WR DATA(0x0c);
  LCD WR DATA(0x11);
  LCD_WR_DATA(0x13);
  LCD WR DATA(0x2c);
  LCD_WR DATA(0x3f);
  LCD WR DATA(0x44);
  LCD WR DATA(0x51);
  LCD WR DATA(0x2f);
  LCD WR DATA(0x1f);
```



```
LCD_WR_DATA(0x1f);
  LCD_WR_DATA(0x20);
  LCD_WR_DATA(0x23);
/*-----*/
  LCD_WR_REG(0x29); //Display on
}
```



# 2.3 Timing Characteristics

8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus

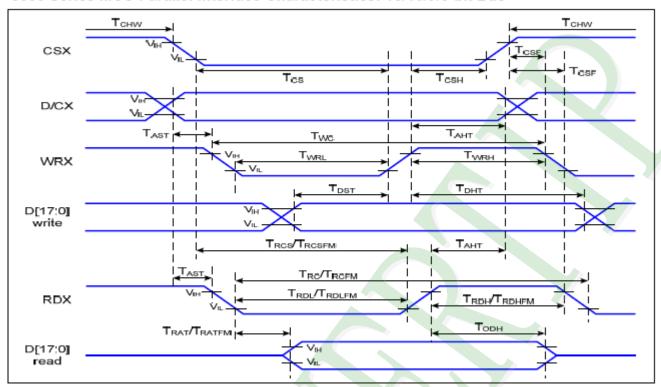


Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)



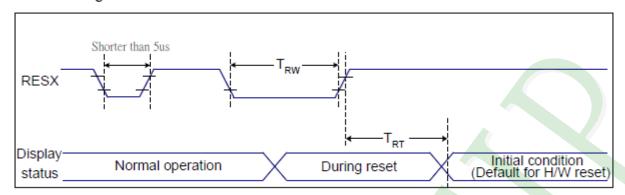


Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T <sub>AST</sub>	Address setup time	0		ns	
DICX	T <sub>AHT</sub>	Address hold time (Write/Read)	10		ns	
	T <sub>CHW</sub>	Chip select "H" pulse width	0		ns	
	T <sub>cs</sub>	Chip select setup time (Write)	15		ns	
CSX	T <sub>RCS</sub>	Chip select setup time (Read ID)	45		ns	
CSA	T <sub>RCSFM</sub>	Chip select setup time (Read FM)	355		ns	- >/
	T <sub>CSF</sub>	Chip select wait time (Write/Read)	10		ns	
	T <sub>CSH</sub>	Chip select hold time	10		ns	
	T <sub>wc</sub>	Write cycle	66		ns	
WRX	T <sub>WRH</sub>	Control pulse "H" duration	15		ns	
	$T_{WRL}$	Control pulse "L" duration	15		ns	
	T <sub>RC</sub>	Read cycle (ID)	160		ns	
RDX (ID)	T <sub>RDH</sub>	Control pulse "H" duration (ID)	90		ns	When read ID data
	$T_{RDL}$	Control pulse "L" duration (ID)	45		ns	
RDX	T <sub>RCFM</sub>	Read cycle (FM)	450		ns	When read from
(FM)	T <sub>RDHFM</sub>	Control pulse "H" duration (FM)	90		ns	frame memory
(I IVI)	$T_{RDLFM}$	Control pulse "L" duration (FM)	355		ns	maine memory
D[17:0]	T <sub>DST</sub>	Data setup time	10	)	ns	For CL=30pF
	$T_DHT$	Data hold time	10		ns	
	$T_{RAT}$	Read access time (ID)		40	ns	
	$T_{RATFM}$	Read access time (FM)		340	ns	
	T <sub>ODH</sub>	Output disable time	20	80	ns	

8080 Parallel Interface Characteristics



#### Reset Timing:



Reset Timing

VDDI=1.65 to 3.6V, VDD=2.4 to 3.6V, AGND=DGND=0V, Ta=25 ℃

Related Pins	Symbol	Parameter	MIN	MAX	Unit
	TRW	Reset pulse duration	10	1	us
RESX	TRT	TRT Reset cancel	-	5 (Note 1, 5)	ms
	IKI	Reset cancer		120 (Note 1, 6, 7)	ms

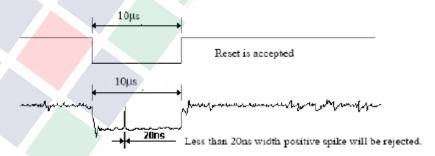
#### Reset Timing

#### Notes:

- The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
  - 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

- 3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
  - 4. Spike Rejection also applies during a valid reset pulse as shown below:

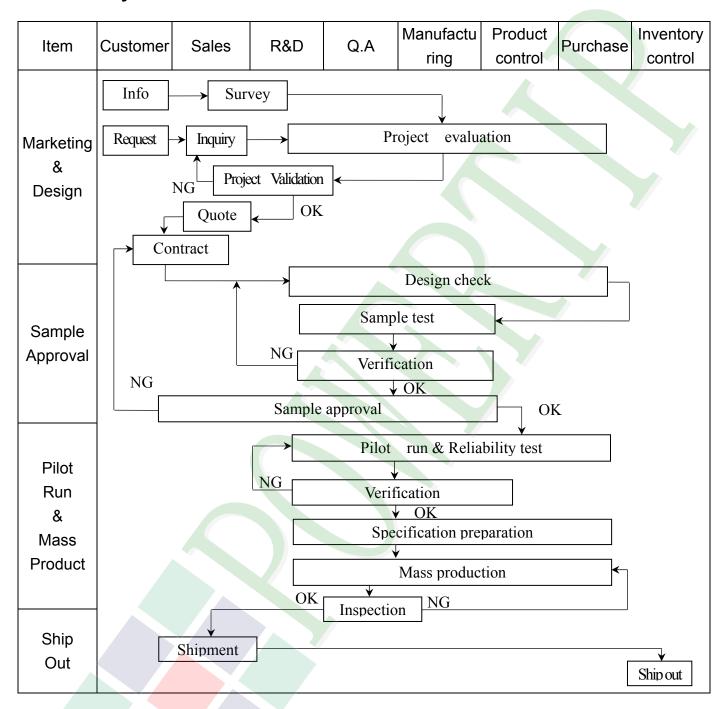


- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

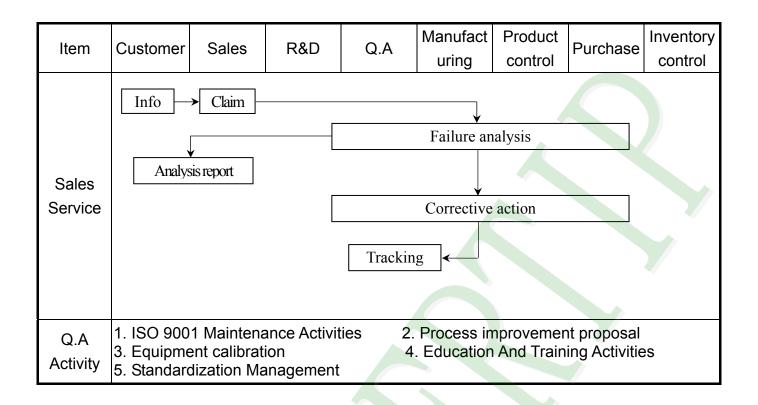


# 3. QUALITY ASSURANCE SYSTEM

# 3.1 Quality Assurance Flow Chart









# 3.2 Inspection Specification

◆Scope : The document shall be applied to TFT-LCD Module for less than 3, 5" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level: Major Defect AQL: 0, 4 ; Minor Defect AQL: 1, 5

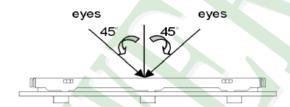
◆OUT Going Defect Level: Sampling.

◆Standard of the product appearance test:

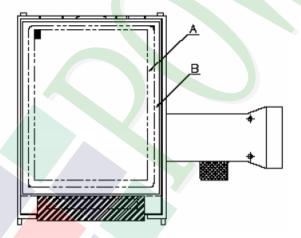
a. Manner of appearance test:

(1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area : Outside of viewing area

(4). Standard of inspection: (Unit: mm)



# ◆Specification For TFT-LCD Module Less Than 3, 5":

NO	Item			Criteri	on	Level
		1. 1The part number is inconsistent with work order of production.				Major
01	Product condition	1. 2 Mix	ed prod	uct types.		Major
		1. 3 Asso	embled i	n inverse direction.		Major
02	Quantity	2. 1The	quantity	is inconsistent witl	h work order of production.	Major
03	Outline dimension		duct din gram.	nension and structu	ure must conform to structure	Major
		4. 1 Mis	sing line	character and icon		Major
	Electrical Testing	4. 2 No function or no display.				
04		4, 3 Display malfunction.				
		4. 4 LCD viewing angle defect.				Major
		4. 5 Cur	rent cor	sumption exceeds p	product specifications.	Major
		_				
				Item	Acceptance (Q'ty)	
	Dot defect			Bright Dot	≦ 2	
			Dot	Dark Dot	≦ 3	
٥٦	(Bright dot \		Defect	Joint Dot	≦ 2	
05	Dark dot)			Total	≦ 3	Minor
		5. 1 Inspection pattern: full white, full black, Red, Green and				t
	On -display			blue screen	18.	
				as dot defect if defe		
		5. 3 The	distanc	e between two dot d	lefect ≧5 mm.	



#### ◆Specification For TFT-LCD Module Less Than 3, 5":

NO	Item	Criterion			
		6. 1 Round type ( Non-display or	· display):		
		Dimension	Acceptance	(Q'ty)	
	Black or white	(diameter∶Φ)	A area	B area	
	dot v scratch v	$\Phi \le 0.15$	Ignore		
	contamination	$0.15 < \Phi \leq 0.20$	2		
	Round type	$0.20 < \Phi \leq 0.30$	2	Ignore	
	→ <u>x</u>   ← ↓	$\Phi > 0.30$	0		
06	Y Y	Total	3		Minor
	$\Phi = (x+y)/2$	6. 2 Line type( Non-display or dis	splay):		- Willion
	Line type	Dimension	Acceptan	ce (Q'ty)	
	± w	Length (L) Width (W)	A area	B area	
	↑ w	W ≤ 0.0	3 Ignore		
	L L	$L \le 5.0$ $0.03 < W \le 0.05$	5 3		
		W >0.0	As round type	Ignore	
		Total	3		
		Dimension (diameter : Φ)	Acceptance (		
		$\Phi \leq 0.20$	A area	B area	
07	Polarizer		Ignore		Minor
	Bubble	$0.20 < \Phi \leq 0.50$	3	Ignore	
		$\Phi > 0.50$	0		
		Total	3		



# ◆Specification For TFT-LCD Module Less Than 3.5″:

NO	Item	Criterion		Level
		Z : The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length	
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and cra	ack between panels:	
		Z Z	Z X	
08	The crack of glass	SP Y [OK]	SP [NG]	Minor
		Seal width	Y	
		X Y	z	
		≦ a Crack can't enter viewing area	≦1/2 t	
		≤ a Crack can't exceed the half of SP width.	1/2 t < Z ≤2 t	



# ◆Specification For TFT-LCD Module Less Than 3.5″:

NO	Item	Criterion (	Level
		Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  8. 1. 2 Corner crack:	
		$X$ $Y$ $Z$ $\leq 1/5 \text{ a}$ Crack can't enter $Z \leq 1/2 \text{ t}$	
		viewing area  Solution $2 \le 1/2 t$ Viewing area  Solution $2 \le 1/2 t$	
08	The crack of glass		Minor
	The Clack of glass	8.2 Protrusion over terminal:	IVIIIOI
		8.2.1 Chip on electrode pad:	
		X X Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z	
		W X	
		X Y Z	
		Front $\leq a \leq 1/2  \text{W} \leq t$	
		Back $\leq$ a $\leq$ W $\leq$ 1/2 t	



# ◆Specification For TFT-LCD Module Less Than 3, 5":

NO	Item	Criterion	Level
NO 08	The crack of glass	Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  8. 2. 2 Non-conductive portion:  X Y: The width of crack. W: terminal length a: LCD side length 8. 2. 2 Non-conductive portion:  X Y Z  Side length Y  X  Y  Z	Level



# ◆Specification For TFT-LCD Module Less Than 3, 5":

NO	Item	Criterion	Level
		9, 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
	diagram.  10. 2 No short circuits in components on PCB or FPC.  10. 3 Parts on PCB or FPC must be the same as on the production	10. 1 Pin type · quantity · dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
10		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
10			Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
			Minor



# 4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CO	ONDITION		
1	High Temperature Storage Test	Keep in +80 ±2°C 240hrs Surrounding temperature, then storage at normal condition 4hrs.			
2	Low Temperature Storage Test	Keep in −30 ±2°C 240hrs Surrounding temperature, then ste	orage at normal condition 4hrs.		
3	High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H durati Surrounding temperature, then sto (Excluding the polarizer)			
4	Temperature Cycling Storage Test	$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $(30\text{mins})  (5\text{mins})  (5\text{mins})$ $20 \text{ Cycle}$ Surrounding temperature, then storage at normal condition 4hrs.			
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-  1. Temperature ambiance: 15°C · 2. Humidity relative: 30% ~ 60% 3. Energy Storage Capacitance(C 4. Discharge Resistance(Rd): 330 5. Discharge, mode of operation: Single Discharge (time between s (Tolerance if the output voltage in	s+Cd): 150pF±10% 0Ω±10% uccessive discharges at least 1 sec)		
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X \ Y \ Z) duration for 2 Hrs</li> </ol>			
7	Drop Test (Packaged)	Packing Weight (Kg	122 76 61 46		



#### 5. PRECAUTION RELATING PRODUCT HANDLING

#### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### 5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution!( LCM products with Capacitive Touch Panel)
   Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
   Therefore, the touch needs to be thoroughly tested inside the target application.

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}$ C  $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

#### 5.4 TERMS OF WARRANTY

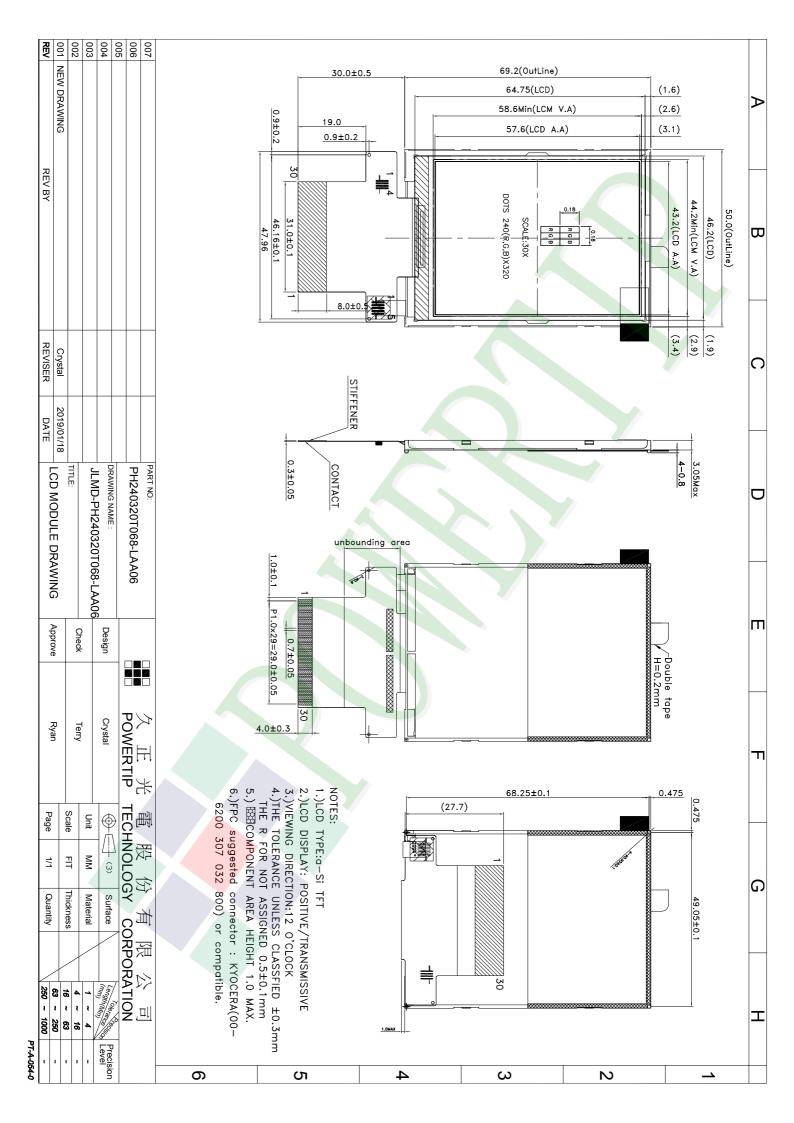
- 5.4.1 Applicable warrant period

  The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
  - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in



nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.





#### Approve Check Contact LCM包裝規格書 Ver.001 LCM Packaging Specifications Documents NO. JPKG-PH240320T068-LAA06 Ryan Terry Crystal (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) 1Pcs Weight Item Model Dimensions (mm) **Ouantity** Total Weight PH240320T068-LAA06 50.0 X 69.2X3.05 1 成品 (LCM) 504 0.0138 6.9552 2 多層薄膜(1)POF OTFILM0BA03ABA 19"X350X0.015 6 3 TRAY 盤 (2)Tray TYSG000000161 352 X 260 X 12.3 0.1 48 4.8 4 内盒(3)Product Box BX36627063ABBA 393 X 274 X 68 0.182 6 1.092 OTPLB00PL08ABA 0.0284 2 0.0568 5 保利龍板(4)Polylon board 550 X 393 X 20 570 X 410 X 265 1 6 外紙箱(5)Carton 1.0 BX57041027CCBA 1.0 7 8 9 一整箱總重量 (Total LCD Weight in carton ): Kg±10% 3. 單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box: no per tray 12 x no of tray 7 84 (2) Total LCM quantity in carton: quantity per box x no of boxes 504 84 6 Use empty tray 空盤 (4)保利龍板 (1)多層薄膜 Polylon board POF Put products into the tray (2)TRAY 盤 Tray (5)外紙箱 Carton Tray stacking (3)内盒 Product Box 特 記 事 項 (REMARK) 1. Label Specifications: Detail B 依廠內標準作業 Trav 2 圓角 Tray 1 2.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.